

Vishay Siliconix

N-Channel 30 V (D-S) MOSFET

FEATURES

Definition

APPLICATIONS

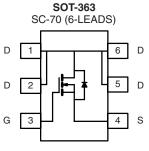
• Halogen-free According to IEC 61249-2-21

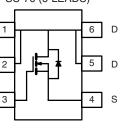
Compliant to RoHS Directive 2002/95/EC

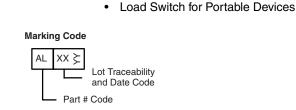
TrenchFET[®] Power MOSFET

- 100 % $\rm R_{g}$ and UIS Tested

PRODUCT SUMMARY						
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)			
30	0.057 at V _{GS} = 10 V	5.6 ^a	5.5			
	0.082 at V _{GS} = 4.5 V	4.7	5.5			







Top View

Ordering Information: Si1472DH-T1-E3 (Lead (Pb-free) Si1472DH-T1-GE3 (Lead (Pb-free and Halogen-free)

ABSOLUTE MAXIMUM RATING	$\mathbf{S}_{A} = 25$ C, uni				
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	± 20		
Continuous Drain Current (T _J = 150 °C) ^a	T _C = 25 °C		5.6		
	T _C = 70 °C		4.5		
	T _A = 25 °C	I _D	4.2 ^{b, c}		
	T _A = 70 °C		3.4 ^{b, c}	— A	
Pulsed Drain Current		I _{DM}	15		
Avalanche Current		I _{AS}	10		
Repetitive Avalanche Energy	L = 0.1 mH	E _{AS}	5	mJ	
	T _C = 25 °C		2.3		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	1.3 ^{b, c}	— A	
	T _C = 25 °C		2.8		
Maximum Power Dissipation ^a	T _C = 70 °C		1.8		
	T _A = 25 °C	P _D	1.5 ^{b, c}	— W	
	T _A = 70 °C		1.0 ^{b, c}		
Operating Junction and Storage Temperature R	T _J , T _{stq}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	$t \le 5 s$	R _{thJA}	60	80	°C/W	
Maximum Junction-to-Foot (Drain)	Steady	R _{thJF}	34	45		

Notes:

a. Based on T_C = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 125 $^{\circ}\text{C/W}.$



HALOGEN

FREE Available

Si1472DH

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			25.15		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		5.6			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1		3	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
7	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1	nA	
Zero Gate Voltage Drain Current		$V_{DS} = 30$ V, $V_{GS} = 0$ V, $T_{J} = 85$ °C			10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	15			Α	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 4.2 A		0.046	0.057	- Ω	
		V _{GS} = 4.5 V, I _D = 3.5 A		0.065	0.082		
Forward Transconductance	9 _{fs}	V _{DS} = 15 V, I _D = 4.2 A		8.5		S	
Dynamic ^b			I	•	<u> </u>		
Input Capacitance	C _{iss}			380		pF	
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		75			
Reverse Transfer Capacitance	C _{rss}			45			
Total Gate Charge	Q _g	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 4.2 A		7	11	- nC	
				3.3	5		
Gate-Source Charge	Q _{gs}	V _{DS} = 24V, V _{GS} = 4.5 V, I _D = 4.2 A		1.2			
Gate-Drain Charge	Q _{gd}			1.0			
Gate Resistance	R _q	f = 1 MHz		7.1	10.6	Ω	
Turn-On Delay Time	t _{d(on)}			7.0	11	- ns	
Rise Time	t _r	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{I}} = 4.4 \Omega$		56	84		
Turn-Off DelayTime	t _{d(off)}	$I_D \cong 3.4 \text{ A}, V_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$		18	27		
Fall Time	t _f			5.5	9		
Turn-On Delay Time	t _{d(on)}			15	23	- ns	
Rise Time	t _r	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{I}} = 5.4 \Omega$		95	143		
Turn-Off DelayTime	t _{d(off)}	$I_D \cong 2.8 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		12	18		
Fall Time	t _f			7	11		
Drain-Source Body Diode Characterist						<u> </u>	
Continous Source-Drain Diode Current	ا _S	T _C = 25 °C			2.3		
Pulse Diode Forward Current ^a	I _{SM}	·			15	A	
Body Diode Voltage	V _{SD}	I _S = 1.8 А		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			12.3	19	nC	
Body Diode Reverse Recovery Charge	Q _{rr}			5	7.5	ns	
Reverse Recovery Fall Time	t _a	I _F = 2.3 A, dI/dt = 100 A/μs		7.6			
Reverse Recovery Rise Time	t _b			4.7			

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

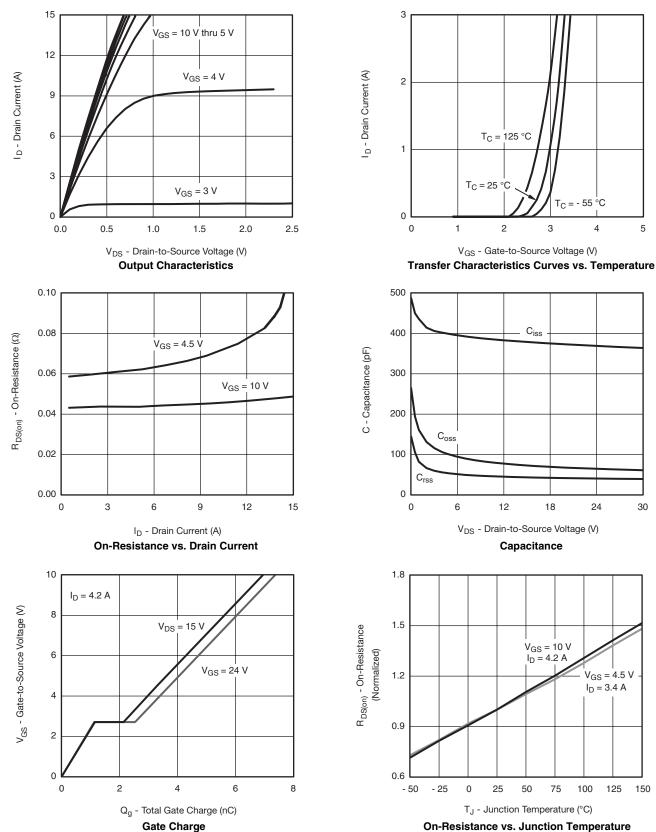
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



Si1472DH Vishay Siliconix

TYPICAL CHARACTERISTICS $T_A = 25$ °C, unless otherwise noted

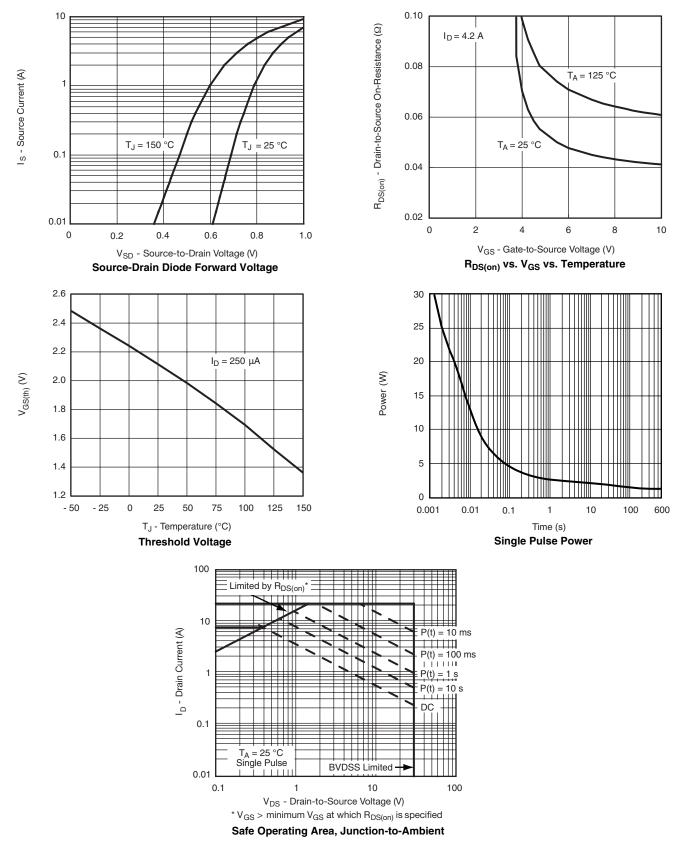


Si1472DH

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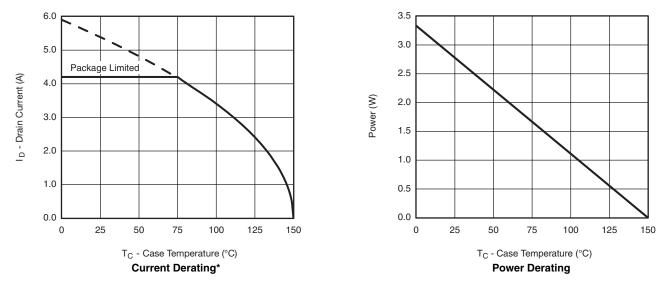
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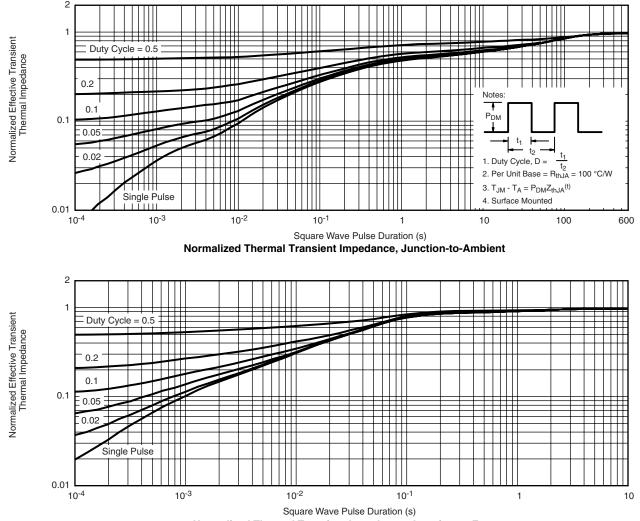


* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?73891.



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